

The Future of Analog IC Technology

# DESCRIPTION

The MP2615B is a monolithic switching charger for a 1 cell lithium-Ion or lithium-Polymer battery packed with built-in power MOSFETs. It's able to achieve up to 2A charge current which can be programmed via an accurate sense resistor over the whole input range.

MP2615B regulates the charge current and full battery voltage using two control loops to realize high accuracy constant current (CC) charge and constant voltage (CV) charge.

Thanks to the constant-off-time (COT) mode control, 99% duty cycle can be achieved when battery voltage is close to the input voltage to keep the charge current always at a relative high level.

Battery temperature and charging status are always monitored for each condition. Two status monitor output pins are provided to indicate the battery charging status and input power status. The MP2615B also features internal reverse blocking protection.

The MP2615B is available in QFN-16 (3mmx3mm) package.

## FEATURES

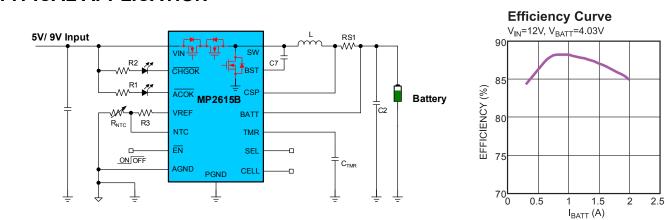
- 4.5V to 18V Operating Input Voltage
- Up to 99% Duty Cycle Operation
- Up to 2A Programmable Charging Current
- ±0.75% Full Battery Voltage Accuracy
- 4.03V and 3.99V Selection for Full Battery Voltage
- Full Integrated Power Switches
- Internal Loop Compensation
- No External Reverse Blocking Diode Required
- Preconditioning for Fully Depleted Battery
- Charging Operation Indicator
- Programmable Safety Timer
- Thermal Shutdown Protection
- Cycle-by-Cycle Over Current Protection
- Battery Temperature Monitor and Protection

## APPLICATIONS

- Smart Phones
- Portable Hand-held Solutions
- Portable Media Players

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# TYPICAL APPLICATION

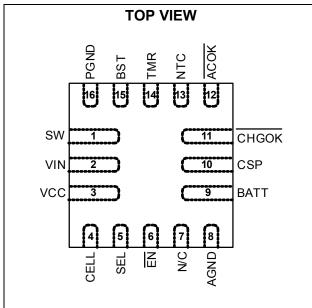


## **ORDERING INFORMATION**

Part Number*	Package	Top Marking	
MP2615BGQ	QFN-16 (3mmx3mm)	AJC	

\* For Tape & Reel, add suffix –Z (e.g. MP2615BGQ–Z);

## PACKAGE REFERENCE



# ABSOLUTE MAXIMUM RATINGS (1)

V <sub>SW</sub>	–0.3V to 23V
VIN, VACOK, VCHGOK	0.3V to 23V
V <sub>BATT</sub> , V <sub>CSP</sub>	–0.3V to 12V
V <sub>BST</sub>	V <sub>SW</sub> + 6V
All Other Pins	–0.3V to 6V
Junction Temperature	150°C
Lead Temperature	
Continuous Power Dissipation (	T <sub>A</sub> = +25°C) <sup>(2)</sup>
	2.5W
Operating Temperature	–40°C to +85°C
	(2)

Recommended Operating Conditions <sup>(3)</sup>				
V <sub>IN</sub>	4.5V to 18V			
V <sub>BATT</sub>	2V to 4.03V			
Operating Junction Temp. (*	T <sub>J</sub> ).–40°C to +125°C			

# *Thermal Resistance* <sup>(4)</sup> *θ<sub>JA</sub> θ<sub>JC</sub>* QFN-16 (3mmx3mm)......50...... 50...... 12... °C/W

#### Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature  $T_J$  (MAX), the junction-toambient thermal resistance  $\theta_{JA}$ , and the ambient temperature  $T_A$ . The maximum allowable continuous power dissipation at any ambient temperature is calculated by  $P_D$  (MAX) = ( $T_J$  (MAX)- $T_A$ )/ $\theta_{JA}$ . Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.



## **ELECTRICAL CHARACTERISTICS**

 $V_{IN} = 12V$ ,  $V_{CELL} = 0V$ ,  $V_{SEL} = 0V$ ,  $C1 = 22\mu$ F,  $C2=22\mu$ F,  $T_A = 25^{\circ}$ C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units	
Input Voltage and Curren							
Input Voltage	V <sub>IN</sub>	Cell Float	4.5	12	18	V	
Under Voltage Lockout Threshold Rising	V <sub>UVLO</sub>		3.55	3.75	3.95	V	
Under Voltage Lockout Threshold Hysteresis				225		mV	
Supply Current	I <sub>SHDN</sub>	EN = 4V, Shutdown Current		0.27		- mA	
oupply ourient	Ι <sub>Q</sub>	EN = 0V, Quiescent Current		1.1			
Power MOS							
High-side Switch On Resistance	R <sub>H_DS(ON)</sub>	Measured from VIN to SW		110		mΩ	
Low-side Switch On Resistance	$R_{L_{DS(ON)}}$			110		mΩ	
Switch Leakage		$\overline{EN} = 4V, V_{SW} = 0V$		0	1	μA	
Frequency and Time Param	eter						
Switching Frequency	F <sub>sw</sub>	V <sub>BATT</sub> = 3.8V,		760		kHz	
Fold-back Frequency		$V_{BATT} = 0V,$		160		kHz	
Minimum Off Time (5)	T <sub>OFF</sub>	V <sub>BATT</sub> = 4.5V,		200		ns	
Charging Parameter							
Terminal Battery Voltage	V <sub>BATT_FULL</sub>	V <sub>SEL</sub> = 0V	4.01	4.03	4.05		
Terminal Battery Voltage	VBATT_FULL	V <sub>SEL</sub> = 4V	3.91	3.93	3.95	1	
Battery Over Voltage	V <sub>BOVP</sub>	V <sub>SEL</sub> = 0V	4.06	4.19	4.32	V	
Threshold	V BOVP	V <sub>SEL</sub> = 4V	3.96	4.09	4.22		
Recharge Threshold at V <sub>BATT</sub>	V <sub>RECH</sub>	V <sub>SEL</sub> = 0V		3.9			
Recitatge Theshold at VBATT	✓ RECH	V <sub>SEL</sub> = 4V		3.8			
Recharge Hysteresis				50		mV	
Trickle Charge Voltage	V <sub>TC</sub>	V <sub>SEL</sub> = 0V		2.97		V	
Threshold	v tC	V <sub>SEL</sub> = 4V		2.9		v	
Trickle Charge Hysteresis				220		mV	
Peak Current Limit		CC <sup>(5)</sup>	3.2	4.2		Α	
		Trickle		2.2			
CC Current	I <sub>cc</sub>	RS1 = 50mΩ	1.8	2	2.2	А	
Trickle Charge Current	I <sub>TC</sub>		5%	10%	15%	I <sub>cc</sub>	



## ELECTRICAL CHARACTERISTICS (continued)

## $V_{IN}$ = 12V, $V_{CELL}$ = 0V, $V_{SEL}$ = 0V, C1 = 22 $\mu$ F, C2=22 $\mu$ F, T<sub>A</sub> = 25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Мах	Units
Termination Current Threshold	I <sub>BF</sub>		5%	10%	15%	I <sub>CC</sub>
$\label{eq:VIN} \begin{array}{ll} V_{\text{IN}} & \text{minimum} & \text{Head-room} \\ (\text{reverse blocking}) \end{array}$		V <sub>IN</sub> - V <sub>BATT</sub>		300		mV
Maximum Current Sense Voltage (CSP to BATT)	V <sub>SENSE</sub>		90	100	110	mV
CSP, BATT Current	$I_{CSP}, I_{BATT}$	Charging disabled			0.5	μA
ACOK/CHGOK Open-drain Sink Current		V <sub>DRAIN</sub> = 0.3V	5			mA
VCC Regulator Output						
VCC Output Voltage	V <sub>CC</sub>		4.25	4.5	4.75	V
VCC Load Regulation	$\Delta V_{CC}$	I <sub>LOAD</sub> =0 to 10mA			10	mV
EN Control						
EN Input Low Voltage					0.4	V
EN Input High Voltage			1.9			V
EN Input Current	I <sub>EN</sub>	$\overline{EN} = 4V$ $\overline{EN} = 0V$		4 0.2		μA
Timer Protection						
Trickle Charge Time	t <sub>Trickle_tmr</sub>	C <sub>TMR</sub> = 0.47uF		30		
CC/CV Charge Time	t <sub>Total_tmr</sub>	$C_{TMR} = 0.47 \mu F$		165		Mins
NTC Protection	-					1
NTC Low Temp Rising Threshold		R <sub>NTC</sub> =NCP18X103, 0°C <sup>(6)</sup> T <sub>A</sub> = -20°C to +85°C <sup>(5)</sup>	70.5	73.3	74.6	
NTC Low Temp Rising Threshold Hysteresis		T <sub>A</sub> 20 C 10 +65 C *		2		%V <sub>cc</sub>
NTC High Temp Falling Threshold		R <sub>NTC</sub> =NCP18X103,50°C <sup>(6)</sup> T <sub>A</sub> = –20°C to +85°C <sup>(5)</sup>	28	29.3	30.6	
NTC Low Temp Falling Threshold Hysteresis		T <sub>A</sub> = -20 C 10 +65 C **		2		
Thermal Protection						
Thermal Shutdown <sup>(5)</sup>	T <sub>SHDN</sub>			150		°C
Thermal Shutdown Hysteresis <sup>(5)</sup>				20		°C
Reverse Leakage Blocking						
Battery Reverse Leakage Current	I <sub>LEAKAGE</sub>				0.5	μA

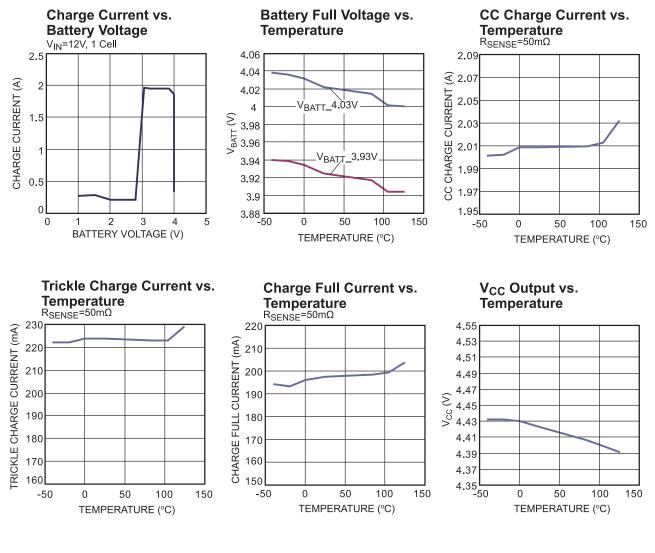
Notes: 5) Guaranteed by design.

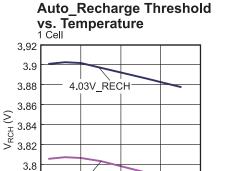
6) The operation temperature limit when using the specified NTC resistor.



## **TYPICAL PERFORMANCE CHARACTERISTICS**

 $V_{IN}$ =12V, C1=C2=22µF, SEL=VCC, CELL=Float, L=6.2µH, R<sub>S1</sub>=50m $\Omega$ , Battery Simulator, T<sub>A</sub>=25°C, unless otherwise noted.





3.93V RECH

50

0

TEMPERATURE (°C)

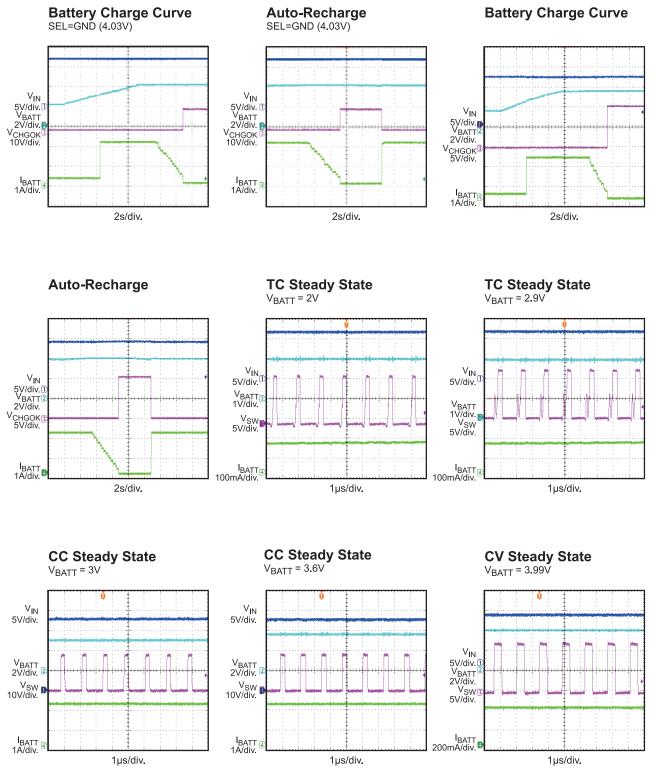
100

150

3.78 3.76 -50

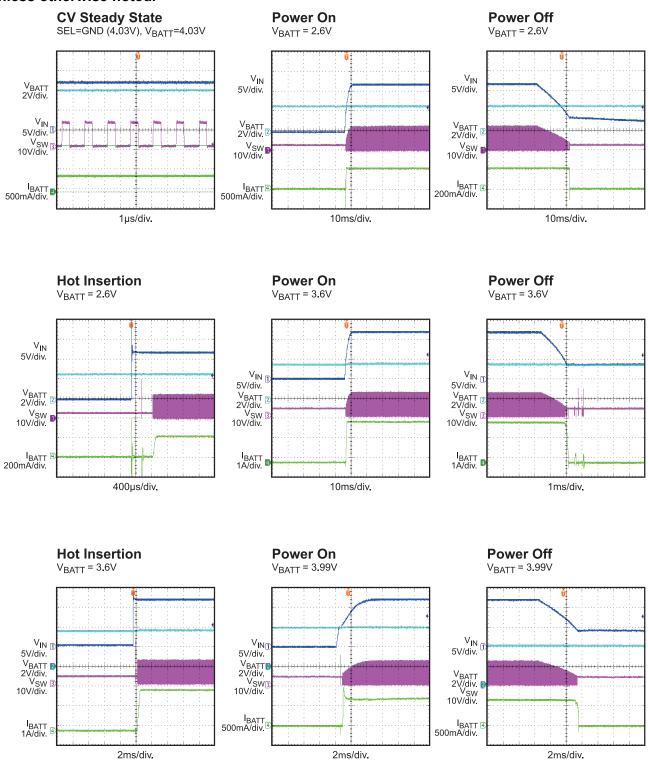


 $V_{IN}$ =12V, C1=C2=22µF, SEL=VCC, CELL=Float, L=6.2µH, R<sub>S1</sub>=50m $\Omega$ , Battery Simulator, T<sub>A</sub>=25°C, unless otherwise noted.



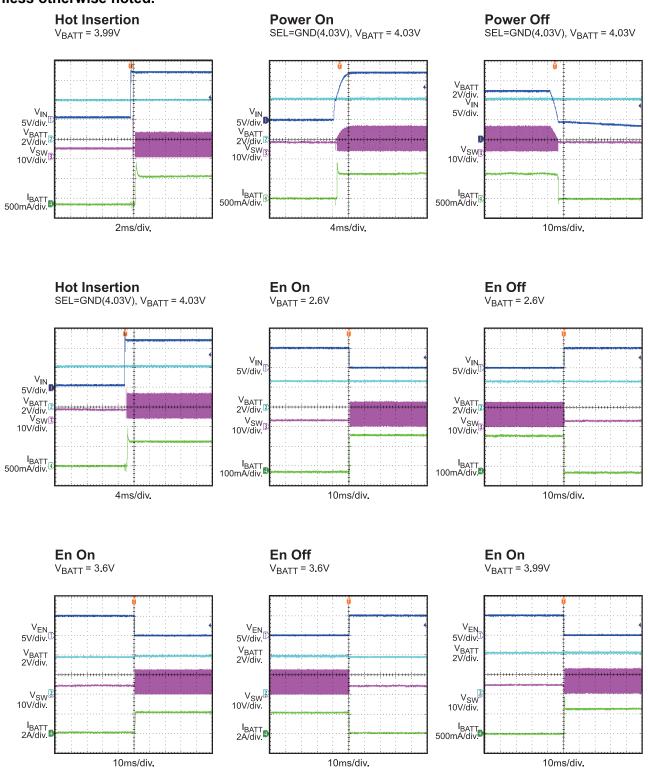


V<sub>IN</sub>=12V, C1=C2=22μF, SEL=VCC, CELL=Float, L=6.2μH, R<sub>s1</sub>=50mΩ, Battery Simulator, T<sub>A</sub>=25°C, unless otherwise noted.



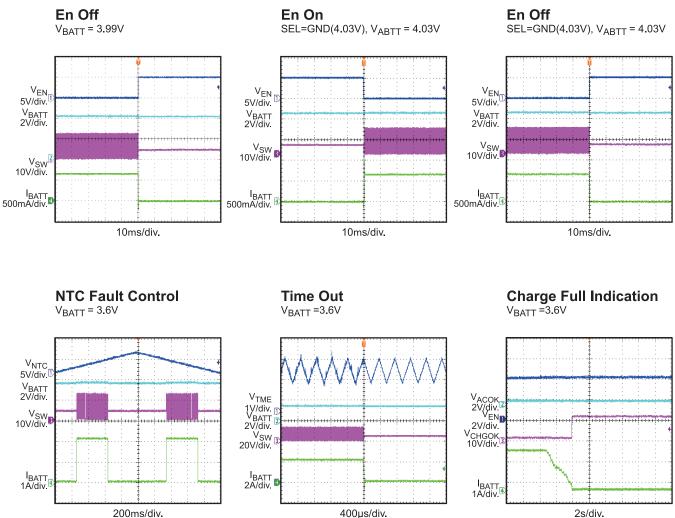


 $V_{IN}$ =12V, C1=C2=22µF, SEL=VCC, CELL=Float, L=6.2µH, R<sub>S1</sub>=50m $\Omega$ , Battery Simulator, T<sub>A</sub>=25°C, unless otherwise noted.





 $V_{IN}$ =12V, C1=C2=22µF, SEL=VCC, CELL=Float, L=6.2µH, R<sub>S1</sub>=50m $\Omega$ , Battery Simulator, T<sub>A</sub>=25°C, unless otherwise noted.





## **PIN FUNCTIONS**

Package Pin #	Name	Description	
1	SW	Switch Output	
2	VIN	Power Supply Voltage.	
3	VCC	coarse Regulator Output. Internally generated 4.5V. Bypass with a 1µF capacitor to AGND lsed to be low-side switch driver and pull-up bias voltage NTC resistive divider. <b>Do no onnect any external load at this pin.</b>	
4	CELL	Keep the pin float or connect to GND.	
5	SEL	Input Pin for Setting Terminal Battery Voltage: SEL = Low-level or Float: $V_{BATT} = 4.03V$ SEL = High-level: $V_{BATT} = 3.99V$	
6	ĒN	On/ Off Control Input. This pin is pulled down to GND with a 1Meg internal resistor.	
7	N/C	NO CONNECT. Please leave this pin floating.	
8	AGND	Analog Ground.	
9	BATT	Positive Battery Terminal.	
10	CSP	Battery Current Sense Positive Input. Connect a resistor RS1 between CSP and BATT.	
11	CHGOK	Charging Completion Indicator. A logic Low indicates charging operation. The pin will become an open drain once the charge is completed or suspended.	
12	ACOK	Valid Input Supply Indicator. A logic Low on this pin indicates the presence of a valid input power supply.	
13	NTC	Thermistor Input. Connect a resistor from this pin to the pin VCC and the thermistor from this pin to ground.	
14	TMR	Internal Safety Timer Control. Connect a capacitor from this node to AGND to set the timer. And the timer can be disabled by connecting this pin to AGND directly.	
15	BST	Bootstrap. This capacitor is needed to drive the power switch's gate above the supply voltage. It is connected between SW and BST pins to form a floating supply across the power switch driver.	
16	PGND	Power Ground.	

FUNCTIONAL BLOCK DIAGRAM

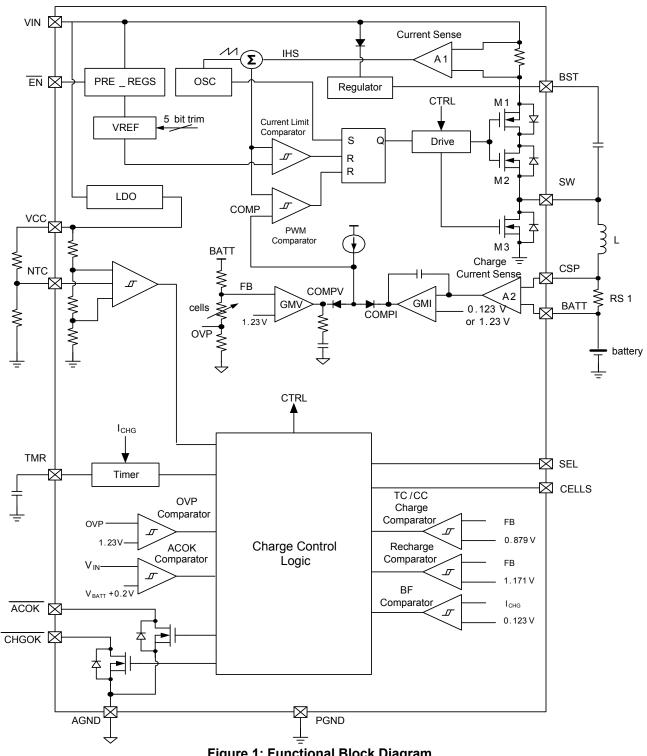


Figure 1: Functional Block Diagram



## **OPERATION**

The MP2615B is a peak current mode controlled switching charger for a 1 cell lithium-ion and lithium-polymer batteries. It integrates both the high-side and low-side switches of the synchronous BUCK converter, which provides high efficiency and saves the PCB space.

## Charge Cycle (Mode change: $TC \rightarrow CC \rightarrow CV$ )

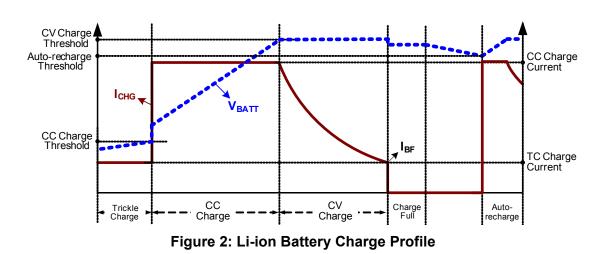
The MP2615B regulates the charge current ( $I_{CHG}$ ) and battery voltage ( $V_{BATT}$ ) using two control loops to realize highly-accurate constant current (CC) charge and constant voltage (CV) charge.

As shown in Figure 2, when the  $V_{BATT} < V_{TC}$ , the MP2615B stays in trickle-charge mode and the output of charge current loop COMPI dominants the control. The battery is charged by a trickle charge current  $I_{TC}$  until the battery voltage reaches  $V_{TC}$ . If the charger stays in the trickle-

charge mode till the trickle-charge timer is triggered, the charging will be terminated.

The MP2615B will enter constant-current charge mode once the battery voltage rises higher than  $V_{TC}$ , and in this mode the current loop continues dominating the control and the charge current will increase from  $I_{TC}$  to  $I_{CC}$  to fast charge the battery

When the battery voltage rises over full battery voltage  $V_{BATT_FULL}$ , the charger enters into constant-voltage mode. In constant voltage mode, the battery voltage is regulated at  $V_{BATT_FULL}$  precisely and the charge current will fall naturally due to the existing equivalent internal resistance of the battery. For the operation flow chart, please also refer to Figure 4.





#### **Charge Full Termination and Auto-Recharge**

When the charge current drops below the termination threshold (I<sub>BF</sub>) during the CV charge phase, the charger will stop charging and the CHGOK pin becomes open drain. The timer will also be reset and turned off. Once the battery voltage decrease below the recharge threshold V<sub>RECH</sub>, recharging will automatically kick in and the timer restarts a new charge cycle.

#### **COT Charge Mode**

MP2615B uses the floating ground method to drive the high-side MOSFET of the buck converter. During the off-time of the high-side MOSFET, the BST capacitor is recharged and the voltage across it is used as the HS-MOS gate drive. Thus a minimum off-time 200ns is required to maintain sufficient voltage at BST capacitor.

When the 200ns minimum off-time is achieved due to a large duty cycle, the MP2615B enters into the COT (constant off-time) charge mode. In this mode of operation, Switching frequency is decreased in order to achieve up to 99% duty cycle.

#### **Charge Status Indication**

MP2615B has two open-drain status outputs, CHGOK pin and ACOK pin. The ACOK pin goes low when the input voltage is 300mV larger than battery voltage and over the under voltage lockout threshold. Pin CHGOK is used to indicate the status of the charge cycle. Table 1 summarized the operation of both CHGOK and ACOK according to the status of charge

100		orung		รเลเนร	or charge.	
	Table	1 Ch	arging	Status	Indication	

ACOK	CHGOK	Charger Status			
Low	Low	In charging			
Low	High impedance	End of charge; NTC fault; Timer out; EN disable; Thermal shutdown;			
High	High	V <sub>IN</sub> absent;			
impedance	impedance	$V_{IN} - V_{BATT} < 0.3V$			

#### **Safety Timer Operation**

The MP2615B has an internal safety timer to terminate charging if the timer times out. The capacitor C<sub>TMR</sub> connected between the TMR pin and GND is used to set the internal oscillator period.

> $T_{P}(seconds) = 0.46 \times C_{TMP}(uF)$ (1)

This timer limits the max trickle charge time to 8192 internal oscillating period. If the charger stays in trickle charge mode for longer than the max oscillating periods, it will be terminated and the CHGOK becomes open drain to indicate the timer-out fault. If the charge successfully goes through trickle charge within the allowed time limit, it enters into the CC charge mode and the timer continues to count the oscillating periods. When the battery is charged full, the timer turns off and clears the counter, waiting for the autorecharge to restart.

If the charge time during CC/CV mode exceeds 49152 oscillating periods and the battery full has not been qualified, the charger will be terminated and a timer-out fault is also indicated by floating the CHGOK. The charger can exit the timer-out fault state and the on-chip safety timer restarts counting when one of the following conditions occurs:

- The battery voltage falls below the autorecharge threshold V<sub>RECH</sub>.
- A power-on-reset (POR) event occurs;
- EN pin is toggled. •

The timer can be disabled by pulling TMR-pin to AGND.

Thus, the trickle mode charge time is:

$$t_{\text{Trickle tmr}}(\text{minutes}) = 62.8 \times C_{\text{TMR}}(\text{uF})$$
 (2)

If connect a  $C_{TMR}$  of 0.47 $\mu$ F, the trickle charge time is about 30 minutes.

The CC/CV mode charge time is:

 $t_{Total tmr}$  (hours) =  $6.28 \times C_{TMR}$  (uF) (3)

If connect a C<sub>TMR</sub> of 0.47uF, the CC/CV charge time is 2.95 hours.



#### Negative Thermal Coefficient (NTC) Thermistor

The NTC pin allows MP2615B to sense the battery temperature using the Negative Thermal Coefficient (NTC) resistor available in the battery pack to ensure safe operating environment of the battery. A resistor with appropriate value should be connected from VCC to NTC pin and the thermistor is connected from NTC pin to AGND. The voltage on NTC-pin is determined by the resistor divider whose divide-ratio depends on the battery temperature. When the voltage at NTC pin falls out of the NTC window range, the charging will pause until battery temperature goes back into the normal operation conditions

As a result the MP2615B will stop charging and report this condition to the status pins, the timer will also be suspended but will continue counting from where they left off when charging resumes.

### **Short Circuit Protection**

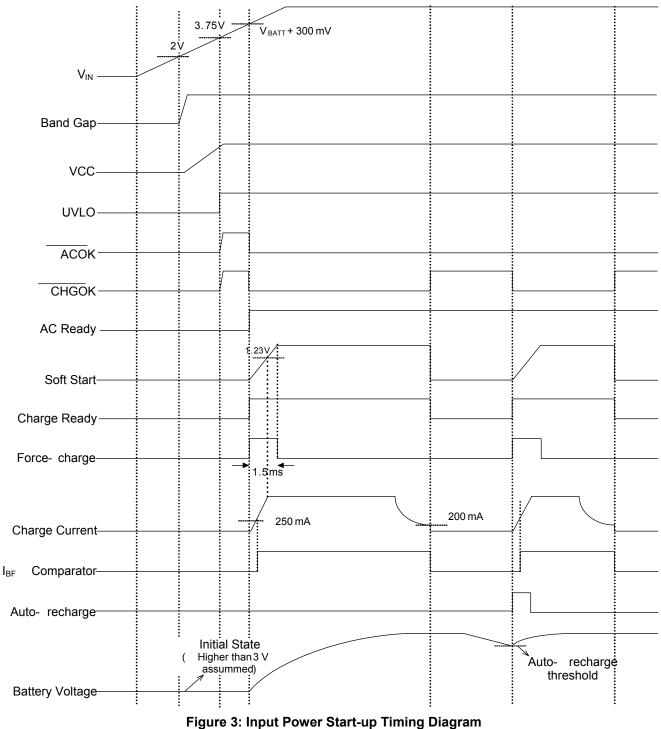
The MP2615B has an internal comparator to check for battery short circuit. Once  $V_{BATT}$  falls below 2V, the device detects a battery-short status and the cycle-by-cycle peak current limit falls to about 2.2A to limit the current spike during the battery-short transition. Furthermore, the switching frequency also folds back to minimize the power loss.

#### **Thermal Shutdown Protection**

To prevent the chip from overheating during charging, the MP2615B monitors the junction temperature, T<sub>J</sub>, of the die. Once T<sub>J</sub> reaches the thermal shutdown threshold (T<sub>SHTDWN</sub>) of 150°C, the charger converter turns off. Once the T<sub>J</sub> falls below 130°C the charging will restart.

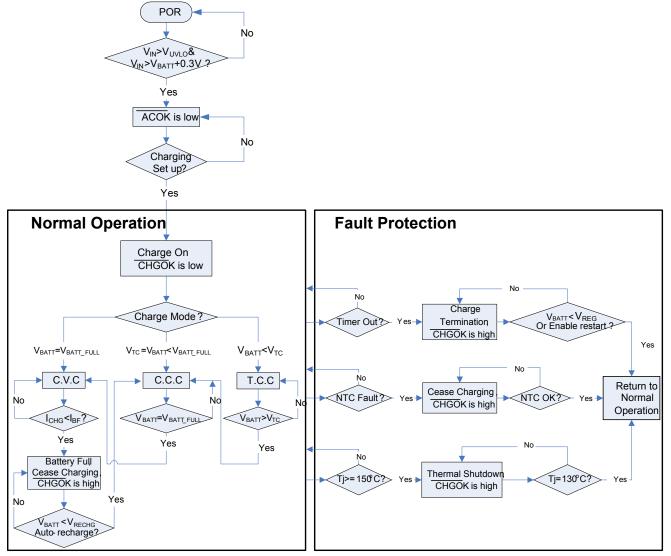


## INPUT POWER UP START UP TIMING FLOW





# **OPERATION FLOW CHART**



**Figure 4: Operation Flow Chart** 

## APPLICATION INFORMATION COMPONENT SELECTION

## **Charge Current Setting**

The constant charge current (I<sub>CC</sub>) of MP2615B can be set by the sense resistor RS1 (see Typical Application). The equation to determine the programmable CC-charge current is expressed as following,

$$I_{CC} = \frac{100 \text{mV}}{\text{RS1(m}\Omega)} (A)$$
(4)

To get 2A  $I_{CC}$ , a RS1 of 50m $\Omega$  should be selected.

Accordingly, the trickle charge current  $(I_{TC})$  can be obtained by the following equation,

$$I_{TC} = 10\% I_{CC} = \frac{10mV}{RS1(m\Omega)}$$
(A) (5)

#### Inductor Selection

For inductor selection, a trade off should be made between cost, size, and efficiency. An inductor of lower inductance value corresponds with smaller size, but results in higher ripple currents, higher magnetic hysteretic losses, and higher output capacitances. Conversely, higher inductance value is beneficial to getting a lower ripple current and smaller output filter capacitors, but resulting in higher inductor DC resistance (DCR) loss. According to the practical experience, the inductor ripple current should not exceed 15% of the maximum charge current under worst cases. For a MP2615B with a typical 12V input voltage to charge a 1-cell battery, the maximum inductor current ripple occurs at the corner point between trickle charge and CC charge ( $V_{BATT}$  = 3V). Estimate the required inductance as:

$$L = \frac{V_{IN} - V_{BATT}}{\Delta I_{L MAX}} \frac{V_{BATT}}{V_{IN} \cdot f_{S}}$$
(6)

where  $V_{IN}$ ,  $V_{BATT}$ , and  $f_S$  are the typical input voltage, the CC charge threshold, and the switching frequency, respectively. And  $\Delta I_{I \text{ MAX}}$  is the maximum inductor ripple current, which is usually 30% of the CC charge current.

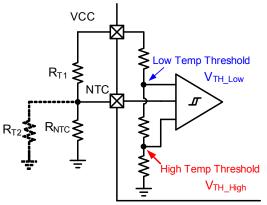
$$\Delta I_{L\_MAX} = 30\% I_{CC}$$
(7)

For the condition that  $I_{CC} = 2A$ ,  $V_{IN} = 12V$ ,  $V_{BATT} =$ 3V and  $f_s = 760$ kHz the calculated inductance is 4.93µH. The inductor saturant current must exceed 2.6A at least and have some tolerance.

To optimize efficiency, chose an inductor with a DC resistance less than  $50m\Omega$ .

#### **NTC Resistor Divider Selection**

Figure 5 shows that an internal resistor divider sets the low temperature threshold and high threshold at 73.3%-VCC temperature and 29.3% VCC, respectively. For a given NTC



**Figure 5: NTC Function Block** 

thermistor, select appropriate  $R_{T1}$  and  $R_{T2}$  to set the NTC window.

The thermistor (NCP18XH103) noted above has the following electrical characteristic:

- At 0°C,  $R_{NTC, Cold} = 27.445 k\Omega$ ;
- At 50°C,  $R_{NTC Hot} = 4.1601 k\Omega$ .

The following equations are derived assuming that the NTC window is between 0°C and 50°C:

$$\frac{R_{T2}//R_{NTC_Cold}}{R_{T1} + R_{T2}//R_{NTC_Cold}} = \frac{V_{TH_Low}}{VREF33} = 73.3\%$$
 (8)

$$\frac{R_{T2}//R_{NTC\_Hot}}{R_{T1} + R_{T2}//R_{NTC\_Hot}} = \frac{V_{TH\_High}}{VREF33} = 29.3\%$$
 (9)

According to Equation (8) (9), and the required battery temperature range to calculate  $R_{T1}$  and RT2.



#### **Input Capacitor Selection**

The input capacitors C1 from the typical application circuit absorbs the maximum ripple current from the buck converter, which is given by:

$$I_{\text{RMS}_{\text{MAX}}} = I_{\text{CC}} \frac{\sqrt{V_{\text{TC}}(V_{\text{IN}_{\text{MAX}}} - V_{\text{TC}})}}{V_{\text{IN}_{\text{MAX}}}}$$
(10)

For a given  $I_{CC} = 2A$ ,  $V_{TC} = 3V$ ,  $V_{IN MAX} = 18V$ , the maximum ripple current is 1A. Select the input capacitors so that the temperature rise due to the ripple current does not exceed 10°C. Use ceramic capacitors with X5R or X7R dielectrics because of their low ESR and small temperature coefficients. For most applications, use a 22µF capacitor.

#### **Output Capacitor Selection**

The output capacitor C2 (see the typical application circuit) is in parallel with the battery. C2 absorbs the high-frequency switching ripple current and smoothes the output voltage. Its impedance must be much less than that of the battery to ensure it absorbs the ripple current. Use a ceramic capacitor because it has lower ESR and smaller size that allows us to ignore the ESR of the output capacitor. Thus, the output voltage ripple is given by,

$$\Delta r_{\rm O} = \frac{\Delta V_{\rm O}}{V_{\rm O}} = \frac{1 - \frac{V_{\rm O}}{V_{\rm IN}}}{8C_{\rm O}f_{\rm S}^{-2}L}$$
(11)

In order to guarantee the  $\pm 0.5\%$  full battery voltage accuracy, the maximum output voltage ripple must not exceed 0.5% (e.g.0.1%). The maximum output voltage ripple occurs at the minimum battery voltage of the CC charge and the maximum input voltage.

For  $V_{IN MAX}$  = 18V,  $V_{CC MIN}$  =  $V_{TC}$  =3V, L = 4.7µH,  $f_S$  = 760kHz,  $\Delta R_{O MAX}$  = 0.2%, the output capacitor can be calculated as,

$$C_{0} = \frac{1 - \frac{V_{TC}}{V_{IN}_{MAX}}}{8f_{s}^{2}L\Delta r_{0_{MAX}}} = 19.2(\mu F)$$
(12)

We can then choose a  $22\mu$ F ceramic capacitor.

#### **PCB Layout Guide**

PCB layout is important to meet specified noise. efficiency and stability requirements. The following design considerations can improve circuit performance,

- 1) Route the power stage adjacent to their grounds. Aim to minimize the high-side switching node (SW, inductor), trace lengths in the high-current paths and the current-sense resistor trace. Keep the switching node short and away from the feedback network.
- 2) Connect the charge current sense resistor to CSP (pin 10), BATT (pin 9). Minimize the length and area of this circuit loop.
- 3) Place the input capacitor as close as possible to the VIN and PGND pins. Place the output inductor close to the IC as and connect the output capacitor between the inductor and PGND of the IC. This minimizes the current path loop area from the SW pin through the LC filter and back to the PGND pin.
- 4) Connect AGND and PGND at a single point.
- 5) Figure 6 is a PCB layout reference design.



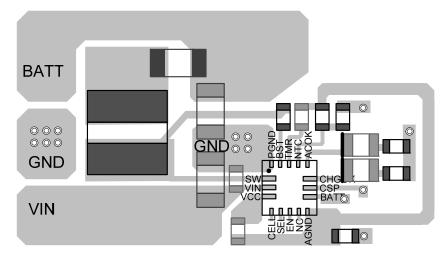


Figure 6: MP2615B PCB Guild Design

# **TYPICAL APPLICATION CIRCUITS**

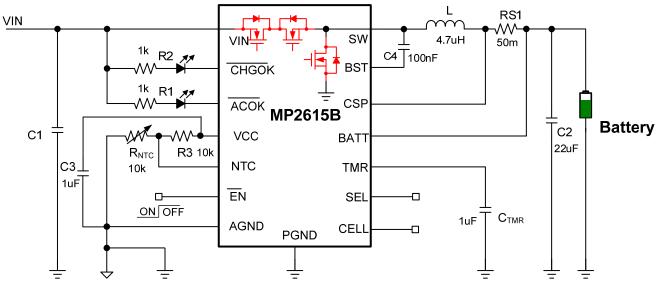
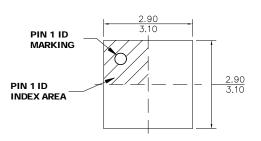


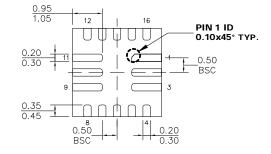
Figure 7: Typical Application Circuit with 12V<sub>IN</sub>.



## PACKAGE INFORMATION



QFN-16 (3mmx3mm)

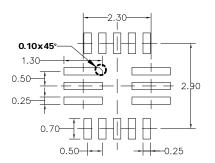


TOP VIEW









#### RECOMMENDED LAND PATTERN

#### NOTE:

 ALL DIMENSIONS ARE IN MILLIMETERS
EXPOSED PADDLE SIZE DOES NOT INCLUDE MOLD FLASH.
LEAD COPLANARITY SHALL BED.10 MILLIMETERS MAX
JEDEC REFERENCE IS MO220.
DRAWING IS NOT TO SCALE

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